

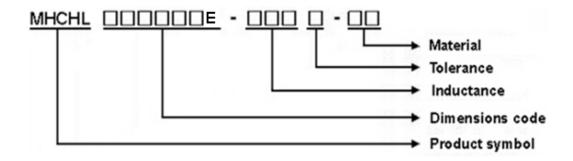
ISO9001 & ISO14001 & TS16949 CHILISIN ELECTRONICS CORP.

RoHS & Halogen Free & REACH Compliance.

SPECIFICATION FOR APPROVAL

Customer :		超利維				
Customer P/N:	! •					
Drawing No :			IE1-8A03	808		
Quantity:	X	Pcs.	Date :	2018/10/25		
Chilisin P/N:		MHCH	L201610E	-R47M-Q8		
	SPI	ECIFIC <i>I</i>	ATION			
		CEPTE				
COMPONENT						
ENGINEER	<u> </u>					
ELECTRICAL						
ENGINEER	<u> </u>					
MECHANICAL						
ENGINEER	 					
APPROVED						
REJECTED						
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奇力新電子(越南廠)有限 Chilisin Electronics (Vietnam) I No 143 - 145, Road No 10, VS Phong, Lap Le Commune, Thu Dist, Haiphong City, Vietnam Tel: 84-316 255 688 Fax: 84 689 E-mail: sales@chilisin.com	Limited SIP Hai uy Nguyen		HuNan Chilisir No. 8, Shaziao	(湖南廠)有限公司 Electronics Technology Co., Ltd Liangshuijing Town, Yuanling ua City, Hunan Province 419601, 67-5882		
Drawn by 張鈺雯 Chang.Yuwen	張釪	Checked 逐 E Chang .	•	Approved by JACKY鍾 Jacky.Chu	ng	

- 1 Scope: This specification applies to Molding power inductors
- 2 Part Numbering:



3 Rating:

Operating Temperature: - 4 0 °C ~ 1 2 5 °C(Including self - temperature rise)

Storage Temperature: - 4 0 °C ~ 1 2 5 °C(after PCB)

- $5 ^{\circ}\text{C} \sim 3 5 ^{\circ}\text{C}$, Humidity $4 5 \% \sim 8 5 \%$ (before PCB)

4 Marking:

No Marking

5 Standard Testing Condition

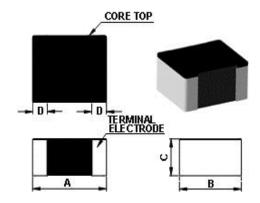
	Unless otherwise specified	In case of doubt
Temperature	Ordinary Temperature(15 to 35℃)	20 to 30°C
Humidity	Ordinary Humidity(25 to 85% RH)	50 to 80 %RH



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MHCHL201610E Series Specification

6 Configuration and Dimensions:



Dimensions in mm

TYPE	MHCHL201610E
А	2.0±0.2
В	1.6±0.2
С	1.0 max
D	0.5±0.3

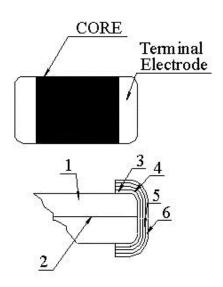
7 Electrical Characteristics:

Part No.	Inductance (uH)	Tolerance (±%)	Test Freq.	Irms(A) Max.(Typ)	Isat(A) Max.(Typ)	RDC(mΩ) Max.(Typ)	
MHCHI 201610F-R47M-Q8	0.47	20	2MHz 0 2V	4.0(4.3)	4 8(5 0)	26(22)	

NOTE

- 1. Operating temperature range $\,$ - $\,$ 4 0 $^{\circ}\text{C} \sim$ 1 2 5 $^{\circ}\text{C} (Including self - temperature rise)$
- 2.Isat for Inductance drop 30% from its value without current.
- 3.Irms for a 40°C temperature rise from 25°C ambient.
- 4.Rated current: Isat or Irms, whichever is smaller
- 5.All test data is referenced to 25°C ambient
- 6.Absolute maximum voltage 20VDC

8.1 Construction:



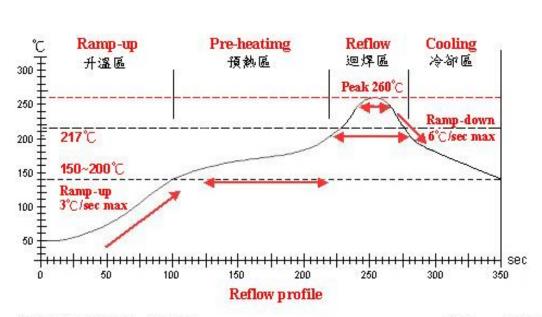
8.2 Material List:

NO	Part	Description
1	Core	Metal Powder
2	Wire	Copper wire
3	Sputter/Plating	Cu
4	Silver Electrode	Ag
5	Plating	Ni
6	Plating	Sn

9 Reliability Of Molding power inductors 1-1.Mechanical Performance

No	Item	Specification	Test Method
1-1-1	Flexure Strength	The forces applied on the right	Test device shall be soldered on the substrate
		conditions must not damage	Substrate Dimension: 100x40x1.6mm
		the terminal electrode and the	Deflection: 2.0mm
		metal body	Keeping Time: 30sec
1-1-2	Vibration	Appearance:No damage (for	Test device shall be soldered on the substrate
		microscope of CASTOR MZ-45 20X	Oscillation Frequency: 10 to 55 to 10Hz for 1min
		Inductance change shall be	Amplitude: 1.5mm
		within ±20%	Time: 2hrs for each axis (X, Y & Z), total 6hrs
1-1-3	Resistance to Soldering Heat	Appearance: No damage	Pre-heating: 150°ℂ, 1min
		More than 75% of the terminal	Solder Composition: Sn/Ag3.0/Cu0.5(Pb-Free)
		electrode should be covered	Solder Temperature: 260±5°C
		with solder.	Immersion Time: 10±1sec
		Inductance: within ±20% of	
		initial value	
1-1-4	Solder ability	The electrodes shall be at	Pre-heating: 150℃, 1min
		least 95% covered with new	Solder Composition: Sn/Ag3.0/Cu0.5(Pb-Free)
		solder coating	Solder Temperature: 245±5°C
		-	Immersion Time: 4±1sec
1-1-5	Terminal Strength Test	No split termination	Test device shall be soldered on the substrate,
		Chip	then apply a force in the direction of the arrow.
		O'''P → F	Force : 5N
			Keeping Time: 10±1sec
		Mounting Pad	

1-2.E	nvironmental Performance					
No	Item	Specification	Test Method			
1-2-1	Temperature Cycle	Appearance: No damage	One cycle:			
		Inductance:within±20% of	Step	Temperature (℃)	Time (min)	
		initial value	1	-40±3	30	
			2	25±2	3	
			3	125±3	30	
			4	25±2	3	
			Total: 10	0cycles		
			Measure	d after exposure in the room conditi	on for 24hrs	
1-2-2	Humidity Resistance		Temperature: 60±2°C			
			Relative Humidity: 90 ~ 95% / Time: 500hrs			
			Measured after exposure in the room condition for 24hrs			
1-2-3	High		Tempera	ture: 85±3°ℂ		
	Temperature Resistance		Relative	Humidity: 0% / Time: 500hrs		
			Measured after exposure in the room condition for 24hrs			
1-2-4	Low		Temperature: -40±3°C			
	Temperature Resistance		Relative Humidity: 0% / Time: 500hrs			
			Measure	d after exposure in the room conditi	on for 24hrs	



Lead-Free(LF) 標準溫度分析範圍

Refer to J-STD-020C

管制項目 Item.	升溫區 Ramp-up	預熱區 Pre-heatimg	迴焊區 Reflow	Peak Temp	冷卻區 Cooling
溫度範圍 Temp.scope	R.T. ~150°C	150°C ~ 200°C	217℃	260±5°ℂ	Peak Temp. ~ 150°C
標準時間 Time spec.	-	60 ~ 180 sec	60 ~ 150 sec	20 ~ 40 sec	R
實際時間 Time result	-	75 ~ 100 sec	90 ~ 120 sec	20 ~ 35 sec	t. − 1

NOTE:

- 1. Re-flow possible times: within 2 times
- 2. Nitrogen adopted is recommended while in re-flow

10 Packaging:

10.1 Packaging -Cover Tape

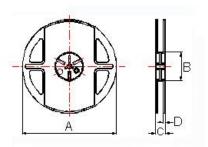
The force for tearing off cover tape is 10 to 100 grams in the arrow direction.



10.2 Packaging Quantity

TYPE	PCS/REEL
MHCHL201610E	3000

10.3 Reel Dimensions



Dimensions in mm

TYPE	Α	В	С	D
MHCHL201610E	178	60	12	1.5

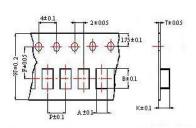


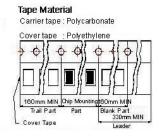
CHILISIN FLECTRONICS CORP.

MHCHL201610E Series Specification

10 Packaging:

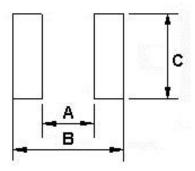
10.4 Tape Dimensions in mm





TYPE	Α	В	Т	W	Р	F	K
MHCHL201610E	1.8	2.20	0.22	8	4	3.5	1.15

11 Recommended Land Pattern:



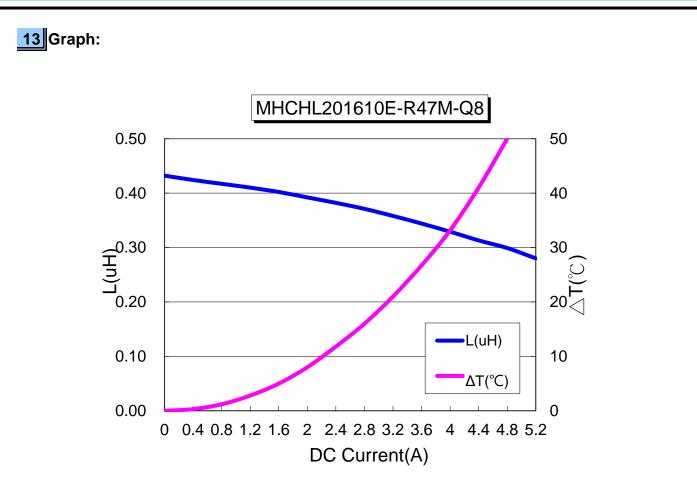
Dimensions in mm

TYPE	Α	В	С
MHCHL201610E	0.7	2.3	1.8

12 Note:

- 1. Please make sure that your product has been evaluated and confirmed against your specifications when our product is mounted to your product.
- 2. Do not knock nor drop.
- 3. All the items and parameters in this product specification have been prescribed on the premise that our product is used for the purpose,under the condition and in the environment agreed upon between you and us. You are requested not to use our product deviating from such agreement.
- 4. Please keep the distance between transformer/coil and other components (refer to the standard IEC 950)
- 5. After manufacturing process, there might be slight irregular shape on the edge of the products, and it's a normal phenomenon that can be neglectable.
- 6. The moisture sensitivity level (MSL) of products is classified as level 1.





单击下面可查看定价,库存,交付和生命周期等信息

>>CHILISIN(奇力新)